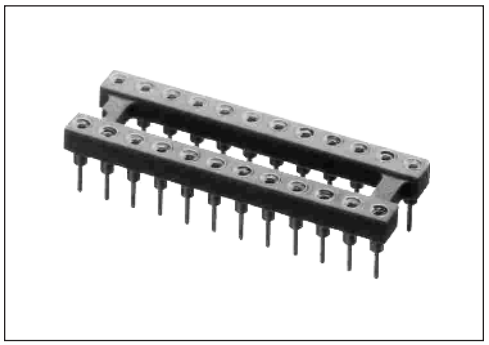
Series 518 Open Frame Collet Socket w/Solder Pin Tails

FEATURES

- Open Frame allows efficient utilization of board space with optimized cooling
- Choose from several pin styles
- Compatible with automatic insertion equipment
- Side-to-side and end-to-end stackable



CUSTOMIZATION: In addition to the standard products shown on this page, Aries specializes in custom design and production. Special materials, platings, sizes, and configurations can be furnished, depending on the quantity. **NOTE**: Aries reserves the right to change product general specifications without notice.

GENERAL SPECIFICATIONS

- BODY MATERIAL: black UL 94V-0 glass-filled 4/6 Nylon
- PIN BODY: Brass 360 1/2-hard per UNS C36000 ASTM B16-00
- PIN BODY PLATING: 10µ [0.25µ] min. Au per MIL-G-45204
  or
  200µ [5.08µ] min. 93/7 Sn/Pb per ASTM B545
  or
  200µ [5.08µ] min. Sn per ASTM B545 Type 1 over 100µ [2.54µ] min. Ni per SAE AMS-QQ-N-290
- 4-FINGERED COLLET CONTACT: BeCu per UNS C17200 ASTM B194-01
- CONTACT PLATING: 200µ [5.08µ] min. 93/7 Sn/Pb per ASTM B545
  or
  200µ [5.08µ] min. Sn per ASTM B545 Type 1
  or
  10µ [0.25µ] Au per MIL-G-45204 over 50µ [1.27µ] min. Ni per SAE AMS-QQ-N-290
- AVAILABLE PLATING: Heavy Au 30µ [0.76µ]
- CONTACT CURRENT RATING: 3 amps
- OPERATING TEMPERATURE: 221°F [105°C] Sn and Sn/Pb plating 257°F [125°C] Au plating
- INSERTION FORCE: 180g/pin
- WITHDRAWAL FORCE: 90g/pin
- NORMAL FORCE: 140g/pin
- MIDGET PIN INSERTION FORCE: 370g/pin
- MIDGET PIN WITHDRAWAL FORCE: 150g/pin
- MIDGET PIN NORMAL FORCE: 240g/pin, based on a 0.018 [0.46] dia. test lead
- ACCEPTS LEAD LENGTHS: from 0.100 [2.54] min. and 0.015-0.025 [0.38-0.64] dia.
- ACCEPTS MIDGET PIN LEAD LENGTHS: from 0.080 [2.03] and up to 0.022 [0.56] dia.

ORDERING INFORMATION

XX-X 518-1 X X

No. of Pins
See Table

Row-to-Row Spacing
3: "Y" = 0.300 [7.62]
4: "Y" = 0.400 [10.16]
6: "Y" = 0.600 [15.24]
9: "Y" = 0.900 [22.86]

Series

Solder Pin Tail

Options
H = Heavy Au on Collet
T = Sn on Collet
M = Midget Solder Tail
(available Au Collet/Sn Shell only)
E = Extra Long Solder Tail

Plating
0 = Au Collet/Sn Shell
1 = Au Collet/Au Shell

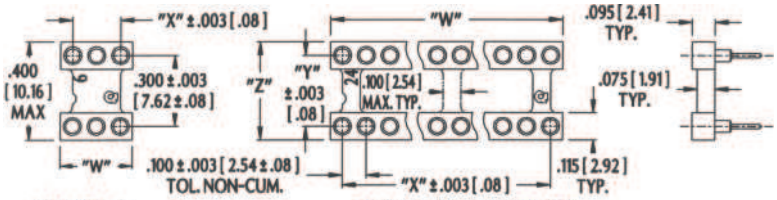
MOUNTING CONSIDERATIONS

- SUGGESTED PCB HOLE SIZE FOR SOLDER PIN TAIL AND EXTRA LONG PIN: 0.030 ±0.002 [0.76 ±0.05] dia.
- SUGGESTED PCB HOLE SIZE FOR MIDGET PIN: 0.040 ±0.002 [1.02 ±0.05] dia.

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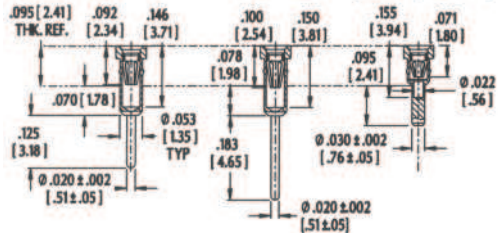
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Series 518 Open Frame
Collet Socket w/Solder Pin Tails



STYLE A

STYLE B,C (2,3 RIB)
Style D (4,5 rib) not shown



Frame Style	No. of Ribs	Centers "Y"	Dim. "Z"	Available Sizes
A	1	0.300 [7.62]	0.400 [10.16]	6
B	2	0.300 [7.62] 0.400 [10.16]	0.400 [10.16] 0.500 [12.70]	8, 14, 16, 18, 20, 24 20, 22
C	3	0.300 [7.62] 0.400 [10.16] 0.600 [15.24]	0.400 [10.16] 0.500 [12.70] 0.700 [17.78]	28 24 24, 28, 32, 40, 48
D	4, 5	0.900 [22.86]	1.000 [25.40]	50, 64

ALL DIMENSIONS: INCHES [MILLIMETERS]

ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED

"W" (# PINS PER ROW) x 0.100 [2.54]
"X" (# PINS PER ROW -1) x 0.100 [2.54]

OTHER COLLET PINS AVAILABLE, CONSULT...
Data Sheet 12017 FOR WIRE WRAP PINS
Data Sheet 12018 FOR SURFACE MOUNT PINS
Data Sheet 12026 and **Data Sheet 12027** for OPEN FRAME CAPACITOR SOCKETS

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

ORDERING INFORMATION

XX - X 518 - 1 XXX XXX

Pin Count (see Table)

Row-to-Row Spacing
- 3 "Y" = 0.300 [7.62]
- 4 "Y" = 0.400 [10.16]
- 6 "Y" = 0.600 [15.24]
- 9 "Y" = 0.900 [22.86]

Series

Solder Pin Tail

Optional Suffix
- H = Heavy Au on Collet
- T = Sn on Collet
- TL = Sn/Pb on Collet
- M = Midget Solder Tail - Available Au Collet, Sn Shell
- MTL = Midget Solder Tail - Available Au Collet, Sn/Pb Shell Only

Plating
- 0 = Au Collet, Sn Shell
- 0E = Au Collet, Sn Shell w/Extra Long Solder Tail
- 0TL = Au Collet, Sn/Pb Shell
- 1 = Au Collet, Au Shell

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